

Evaluating the ADRF5534, 3.1 GHz to 4.2 GHz, Receiver Front End

FEATURES

- ▶ Full featured evaluation board for the [ADRF5534](#)
- ▶ Easy connection to test equipment
- ▶ Thru line for calibration

EQUIPMENT NEEDED

- ▶ DC power supplies
- ▶ Network analyzer

GENERAL DESCRIPTION

The ADRF5534 is an integrated RF, front-end multichip module designed for time division duplex (TDD) applications. The device operates from 3.1 GHz to 4.2 GHz. The ADRF5534 is configured with an LNA and a high-power, silicon, SPDT switch.

This user guide describes the ADRF5534-EVALZ, designed to easily evaluate the features and performance of the ADRF5534. A photograph of the ADRF5534-EVALZ is shown in [Figure 1](#).

Full details about the device are available in the ADRF5534 data sheet, which must be consulted when using the ADRF5534-EVALZ.

EVALUATION BOARD PHOTOGRAPH

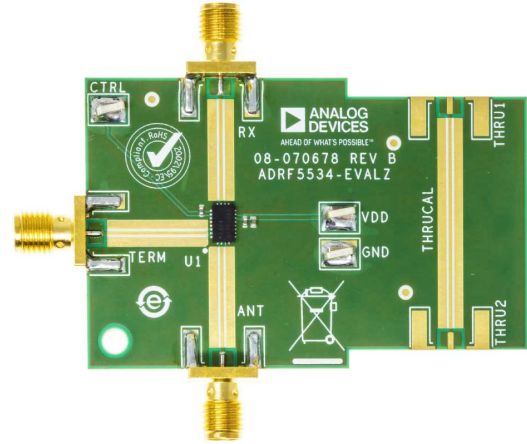


Figure 1. ADRF5534-EVALZ

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REVISION HISTORY**3/2023—Revision 0: Initial Version**

EVALUATION BOARD HARDWARE

OVERVIEW

The ADRF5534-EVALZ is preinstalled with connectors (end launch Subminiature Version A (SMA)) and assembled with the [ADRF5534](#) and the application circuitry of the ADRF5534. All components are placed on the primary side of the ADRF5534-EVALZ. An assembly drawing for the ADRF5534-EVALZ is shown in [Figure 8](#). An ADRF5534-EVALZ schematic is provided in [Figure 9](#).

ADRF5534-EVALZ LAYOUT

The ADRF5534-EVALZ is designed using RF circuit design techniques on an 8-layer printed circuit board (PCB). The PCB stack-up is shown in [Figure 2](#).

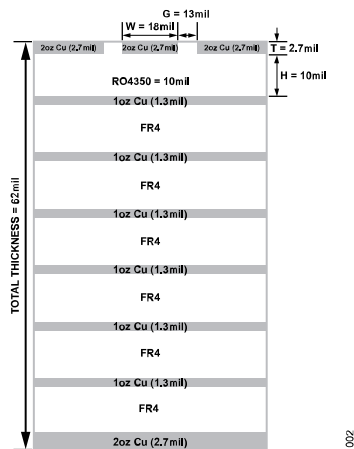


Figure 2. Evaluation Board Stack-Up

The outer copper layers are 2 oz (2.7 mil) thick and the inner layers are 1 oz (1.3 mil) thick. The top dielectric material is 10 mil Rogers 4350B, which provides 50 Ω controlled impedance and optimizes high-frequency performance. The remaining six dielectric layers are FR4 based filler layers that improve the mechanical strength of the ADRF5534-EVALZ and meet the overall board thickness of 62 mil.

All RF traces are routed on the top layer, and the remaining seven layers are ground planes that provide a solid ground for RF transmission lines and help to manage thermal rise on the ADRF5534-EVALZ during high-power operations.

The RF transmission lines are designed using a coplanar waveguide (CPWG) model with a width of 18 mil and a ground spacing of 13 mil to have a characteristic impedance of 50 Ω . Ground via fences are arranged on both sides of a CPWG to improve isolation between nearby RF lines and other signal lines.

The exposed ground pad of the ADRF5534, which is soldered on the PCB ground pad, is the main thermal conduit for heat dissipation. The PCB ground pad is densely populated with filled through vias to provide the lowest possible thermal resistance path temperature from the top to the bottom of the PCB. The connections from the package ground leads to ground are kept as short as possible.

RF INPUTS AND OUTPUTS

The ADRF5534-EVALZ has five edge mounted SMA connectors for the RF inputs and outputs, as shown in [Table 1](#). The SMA connectors on the thru line are not populated by default and can be connected by the user to measure and calibrate out the evaluation board loss effects. Use the thru line on THRU1 and THRU2 to calibrate out the ANT, TERM, and RX evaluation board loss.

Table 1. RF Inputs and Outputs

SMA Connectors	Description
ANT	Antenna input
TERM	Termination output
RX	Receiver output
THRU1	Thru line input or output, DNI
THRU2	Thru line input or output, DNI

POWER SUPPLY AND CONTROL INPUTS

The ADRF5534-EVALZ has one power-supply input, one control input, and one ground, as shown in [Table 2](#). The DC test points are populated on the VDD, CTRL, and GND test points.

A single 5 V supply is connected to the DC test point on the VDD test point. Ground reference can be connected to the GND test point. The typical total current consumption for the ADRF5534 is 120 mA in receive operation. The supply pin of the ADRF5534-EVALZ is decoupled with 100 pF and 4.7 μ F capacitors.

A single 5 V supply is connected to the DC test point on the CTRL test point. The control pin of the ADRF5534-EVALZ is decoupled with 100 pF. When no connection is made to the CTRL control input, the RF channel is in termination mode with LNA powered down.

Table 2. Test Points for Power Supply and Control Inputs

Test Points	Description
VDD	Positive supply voltage
CTRL	Transmit/receive control logic input
GND	Ground

TEST PROCEDURE

BIASING SEQUENCE

To bias up the ADRF5534-EVALZ, perform the following steps:

1. Ground the GND test point.
2. Bias up VDD test point.
3. Bias up the CTRL test point.
4. Apply an RF input signal.

The ADRF5534-EVALZ is shipped fully assembled and tested. Figure 3 provides a basic test setup diagram to evaluate the s-parameters (receive gain, transmit insertion loss and isolation, and RF input and output return losses) using a network analyzer. Note that PSU in Figure 3 means power supply unit. Perform the following steps to complete the test setup and verify the operation of the ADRF5534-EVALZ:

1. Connect the GND test point to the ground terminal of the power supply.
2. Connect the VDD test point to the voltage output terminal of the 5 V supply that sources a current of approximately 120 mA in receive operation or 15 mA for transmit operation.
3. Connect the CTRL test point to the voltage output terminal of the 5 V supply for receive operation. The ADRF5534-EVALZ can be configured in different modes by connecting the CTRL control test point to 5 V or ground, as shown in Table 3.
4. Connect a calibrated network analyzer to the ANT, TERM, and RX SMA connectors. Sweep frequency from 1 GHz to 6 GHz and set power to -25 dBm.
5. The ADRF5534-EVALZ is expected to have a receive gain of 35.5 dB and transmit insertion loss of 0.8 dB at 3.6 GHz. See the expected results in Figure 4 to Figure 6.

Table 3. Truth Table: Signal Path Selection

CTRL	Signal Path Selection	
	Transmit Operation (ANT to TERM)	Receive Operation (ANT to RX)
Low	On	Off, LNA powered down
High	Off, isolation state	On

Additional test equipment is needed to fully evaluate the device functions and performance.

For noise figure evaluation, use either a noise figure analyzer or a spectrum analyzer with noise option. The use of a low excess noise ratio (ENR) noise source is recommended.

For third-order intercept point evaluation, use two signal generators and a spectrum analyzer. A high isolation power combiner is recommended.

For power compression and power handling evaluations, use a two-channel power meter and a signal generator. A power amplifier with great enough power is recommended at the input. Test accessories such as couplers and attenuators must have enough power handling.

The ADRF5534-EVALZ comes with a support plate attached to the bottom side. To ensure maximum heat dissipation and to reduce thermal rise on the ADRF5534-EVALZ during high-power evaluations, the support plate must be attached to a heatsink using thermal grease.

Note that the measurements performed at the SMA connectors of the ADRF5534-EVALZ include the losses of the SMA connectors and the PCB. The thru line must be measured to calibrate out the ADRF5534-EVALZ effects. The thru line is the summation of an RF input line and an RF output line that are connected to the device and equal in length.

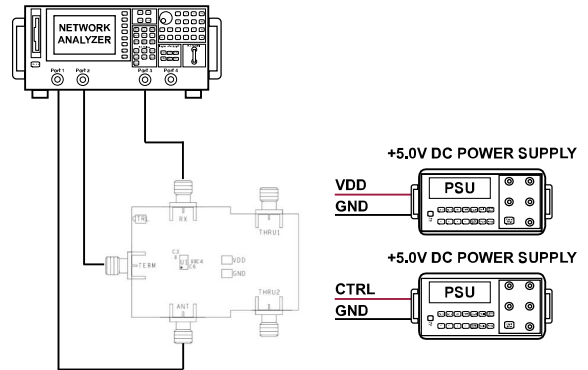


Figure 3. Test Setup Diagram

TEST PROCEDURE

EXPECTED RESULTS

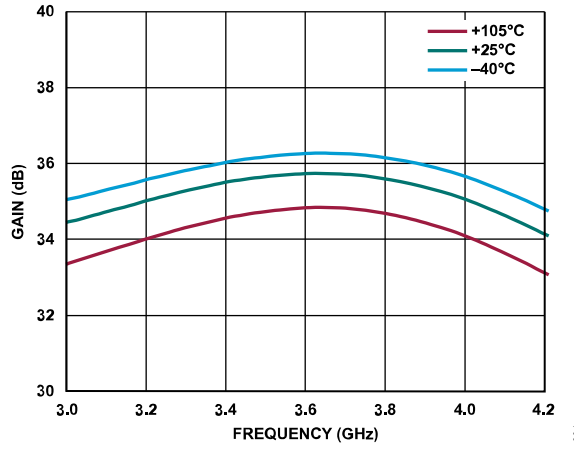


Figure 4. Gain vs. Frequency at Various Temperatures

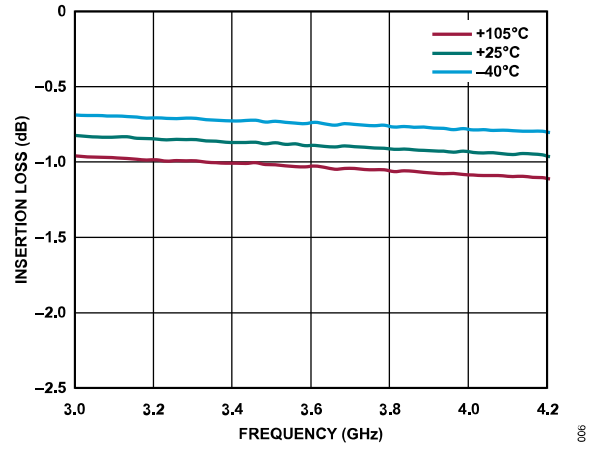


Figure 6. Insertion Loss vs. Frequency at Various Temperatures

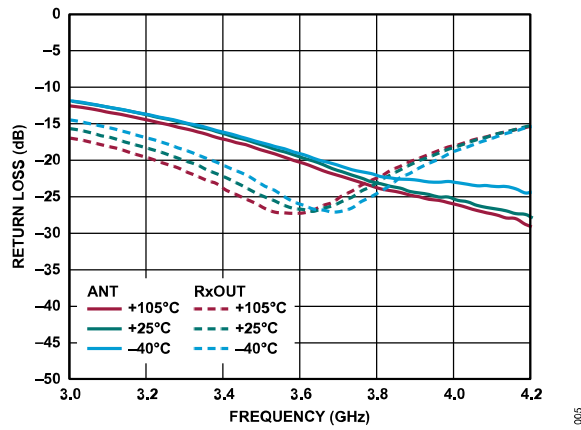


Figure 5. Receive Mode Return Loss vs. Frequency at Various Temperatures

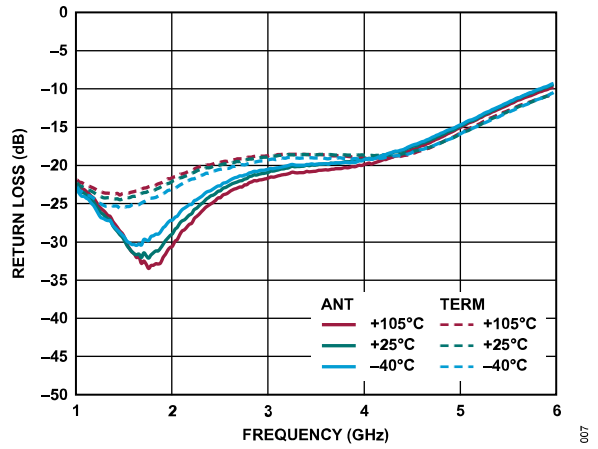


Figure 7. Transmit Mode Return Loss vs. Frequency at Various Temperatures

EVALUATION BOARD ARTWORK AND SCHEMATIC

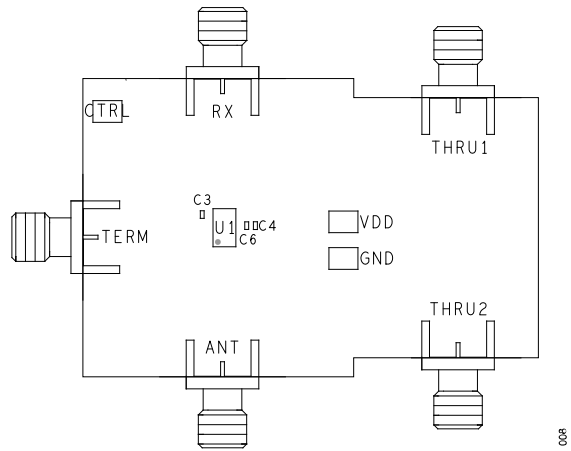


Figure 8. Assembly Diagram

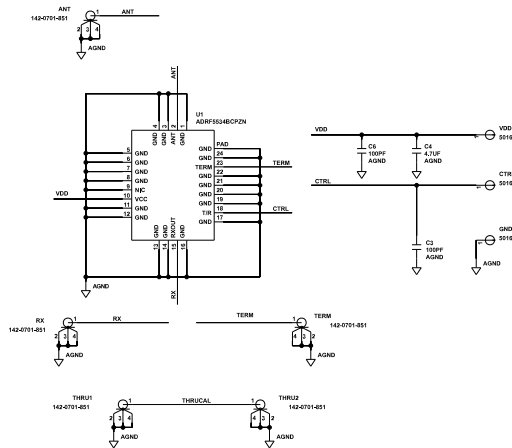


Figure 9. Schematic

ORDERING INFORMATION

BILL OF MATERIALS

Table 4.

Reference Designator	Description	Manufacturer	Part Number
ANT, RX, TERM	PCB mount SMA connectors	Johnson/Cinch Connectivity Solutions	142-0701-851
THRU1, THRU2	PCB mount SMA connectors, do not install (DNI)	Johnson/Cinch Connectivity Solutions	142-0701-851
C3, C6	100 pF capacitors, 50 V, 0402 package	KEMET	C0402C101J5GACTU
C4	4.7 µF capacitors, 10 V, 0402 package	TDK	C1005X5R1A475K050BC
CTRL, VDD, GND	Surface-mount test points	Keystone Electronics	5016
U1	3.1 GHz to 4.2 GHz, receiver front end	Analog Devices, Inc.	ADRF5534
PCB	Printed circuit board	Analog Devices	08-070678B

**ESD Caution**

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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